

/ Descriptions

TO-220F PNP Silicon PNP transistor in a TO-220F Plastic Package.

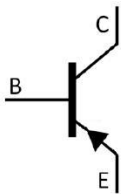
/ Features

h_{FE} - TO-220

High forward current transfer ratio h_{FE} which has satisfactory linearity, low collector to emitter saturation voltage $V_{CE(sat)}$ Full-pack package which can be installed to the heat sink with one screw.

/ Applications

For low-frequency power amplification.

/ Equivalent Circuit**/ Pinning**

PIN1 Base PIN 2 Collector PIN 3 Emitter

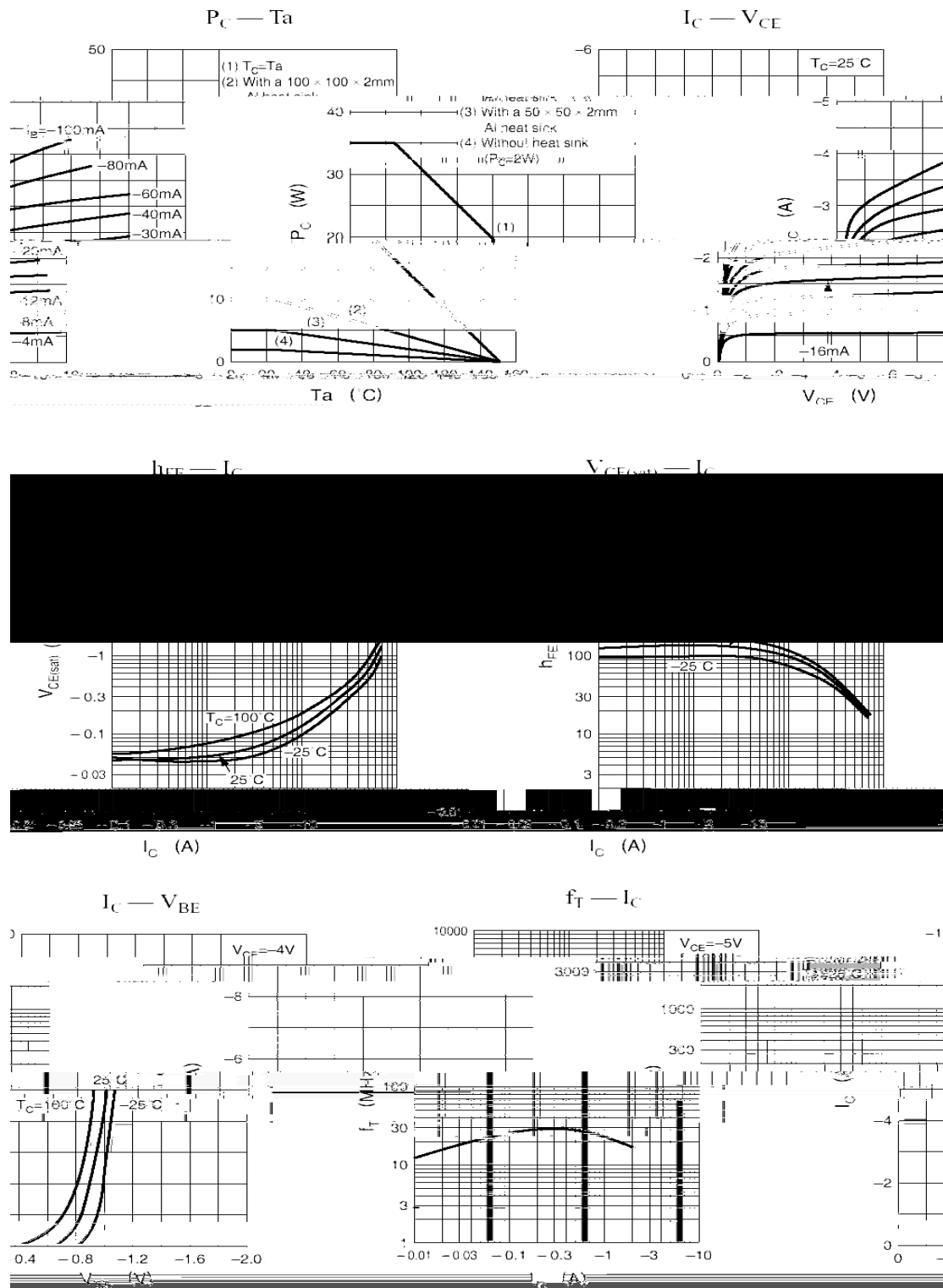
/ h_{FE} Classifications & Marking

h_{FE} Classifications Symbol	Q	P
h_{FE} Range	70 150	120 250

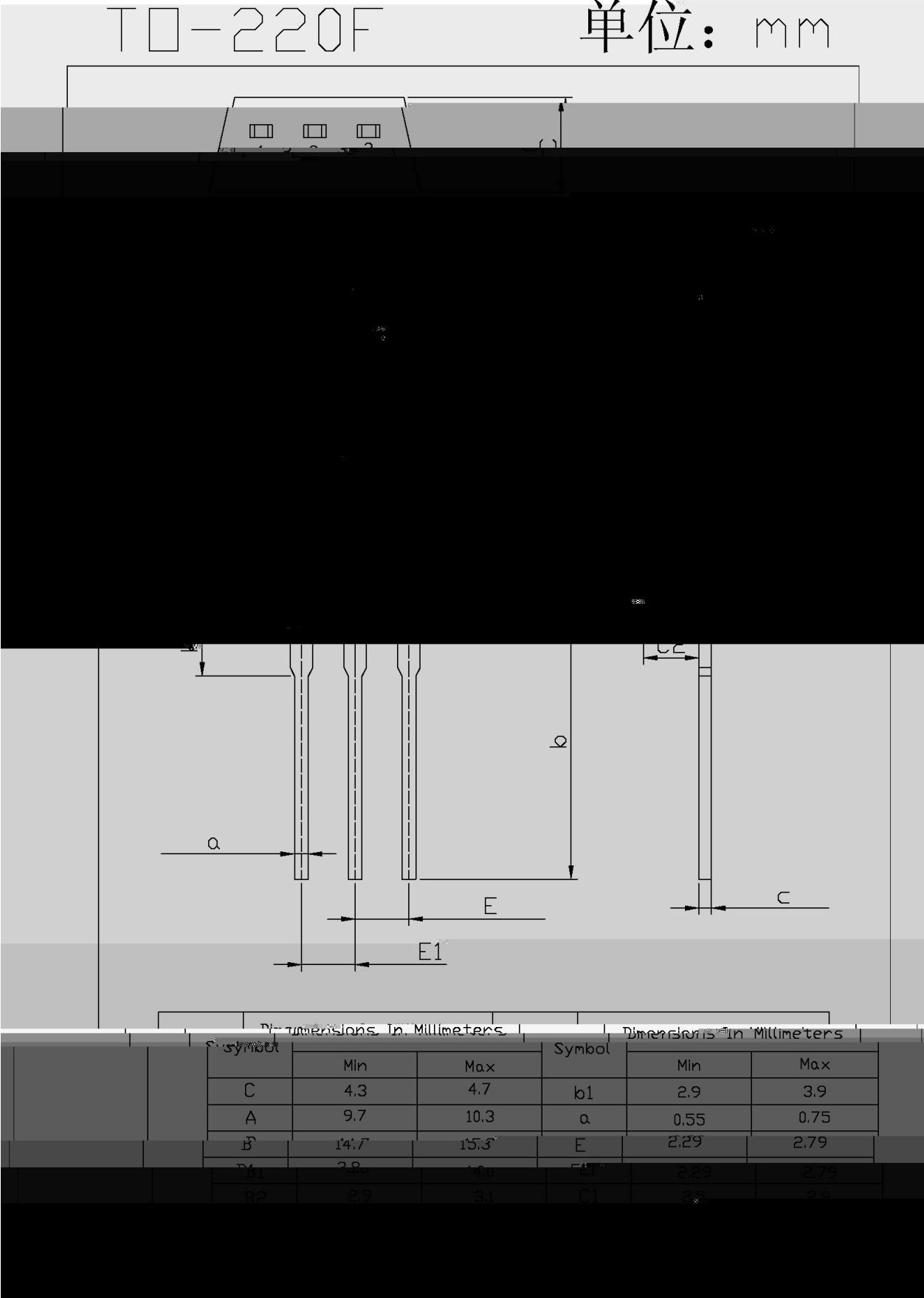
Parameter	Symbol	Rating	Unit
Collector to Base Voltage	V_{CBO}	-60	V
Collector to Emitter Voltage	V_{CEO}	-60	V
Emitter to Base Voltage	V_{EBO}	-5.0	V
Collector Current - Continuous	I_C	-3.0	A
Collector Current – Continuous(Pulse)	I_{CP}	-5.0	A
Collector Power Dissipation	P_C	2.0	W
Junction Temperature	T_j	150	
Storage Temperature Range	T_{stg}	-55 150	

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Collector to Emitter Breakdown Voltage	V_{CEO}	$I_C = -30mA$ $I_B = 0$	-60			V
Collector Cut-Off Current	I_{CEO}	$V_{CE} = -30V$ $I_B = 0$			-300	A
Collector Cut-Off Current	I_{CES}	$V_{CE} = -60V$ $V_{BE} = 0$			-200	A
Emitter Cut-Off Current	I_{EBO}	$V_{EB} = -5V$ $I_C = 0$			-1	mA
DC Current Gain	$h_{FE(1)}$	$V_{CE} = -4.0V$ $I_C = -1.0A$	70		250	
	$h_{FE(2)}$	$V_{CE} = -4.0V$ $I_C = -3.0 A$	10			
Collector to Emitter Saturation Voltage	$V_{CE(sat)}$	I_C				

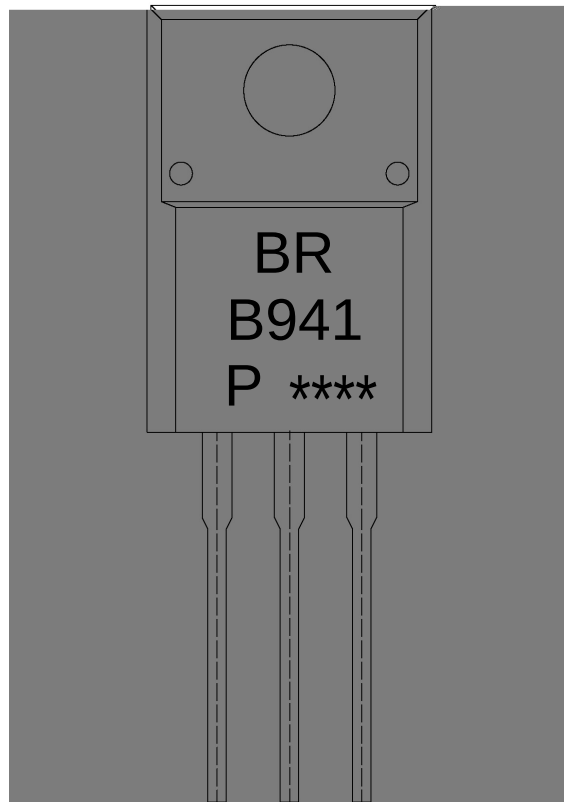
/ Electrical Characteristic Curve



/ Package Dimensions



/ Marking Instructions



BR

B941

Q: h_{FE}

Note:

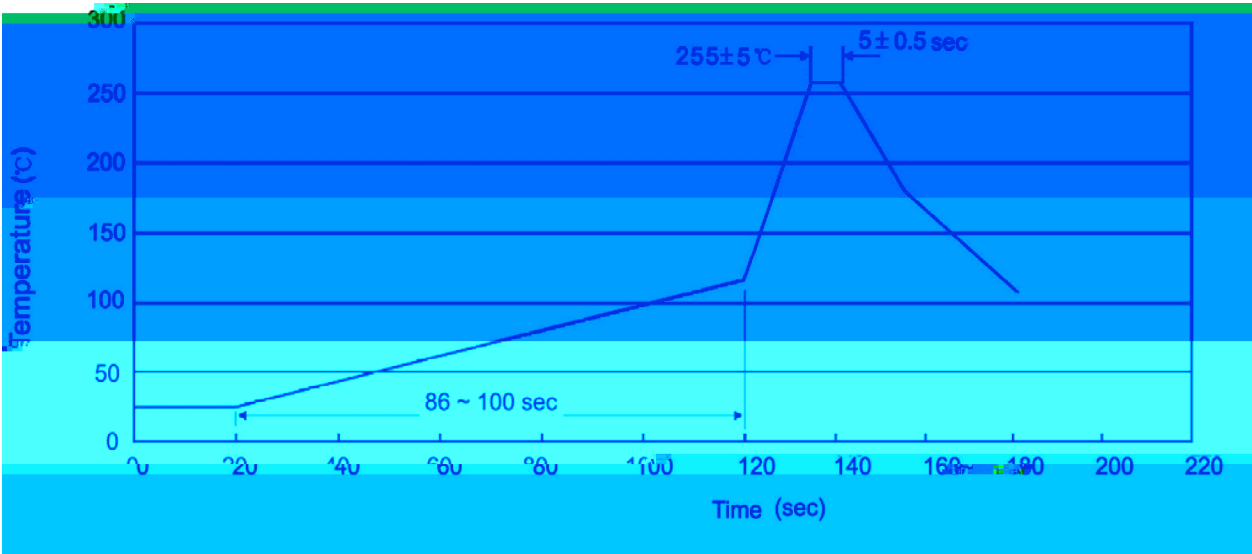
BR: Company Code.

B941: Product Type.

Q: h_{FE} Classifications Symbol

****: Lot No. Code, code change with Lot No.

() / Temperature Profile for Dip Soldering(Pb-Free)



Note:

- | | | | | | |
|---|-------|-----|-----------|---|--------------------------------------|
| 1 | 25 | 150 | 60 | 90sec; | 1.Preheating:25~150 , Time:60~90sec. |
| 2 | 255±5 | | 5±0.5sec; | 2.Peak Temp.:255±5 , Duration:5±0.5sec. | |
| 3 | | 2 | 10 | /sec. | 3. Cooling Speed: 2~10 /sec. |

/ Resistance to Soldering Heat Test Conditions

270±5	10±1 sec.	Temp.:270±5	Time:10±1 sec
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/ Packaging SPEC.

/ BULK

Package Type 封装形式	Units 包装数量
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